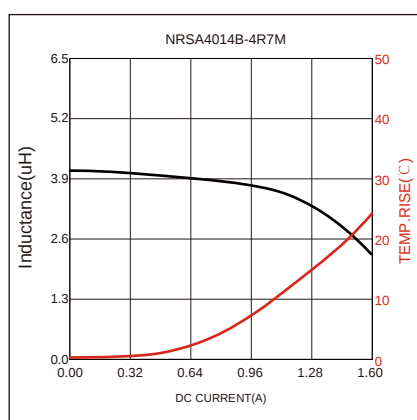
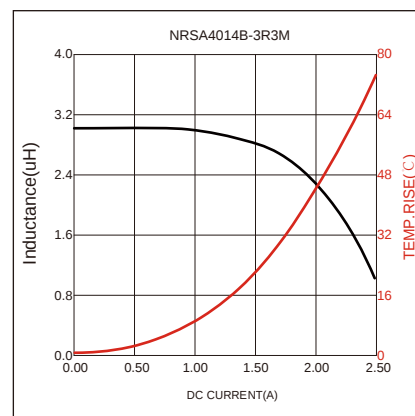
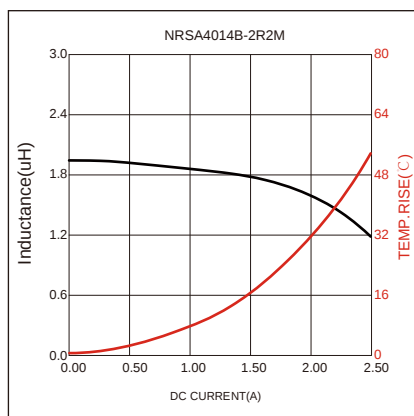
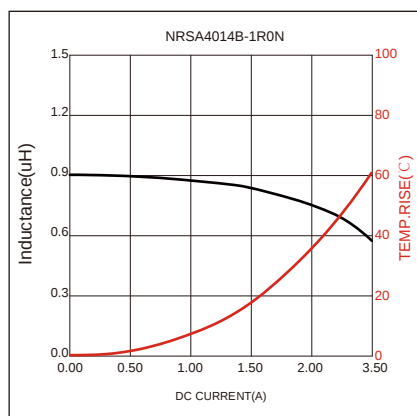




Typical Electrical Characteristics:



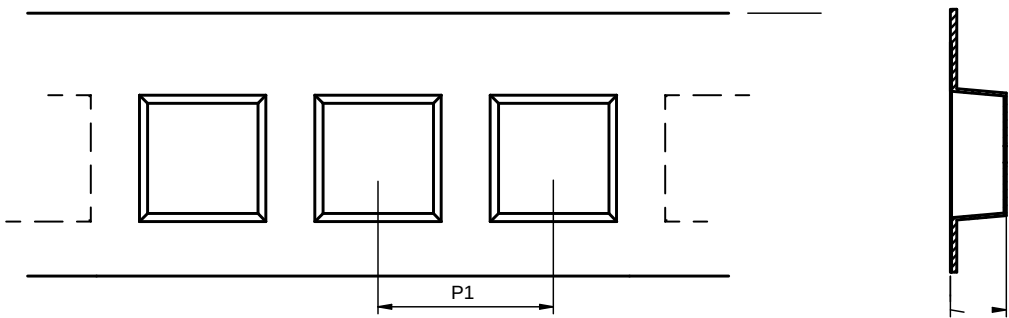


Soldering Reflow:

Preheat condition: 150 ~200℃ / 60~120 sec.
Allowed time above 217℃ : 60~90 sec.
Max temperature: 260℃ .
Allowed Reflow time: 2x max.

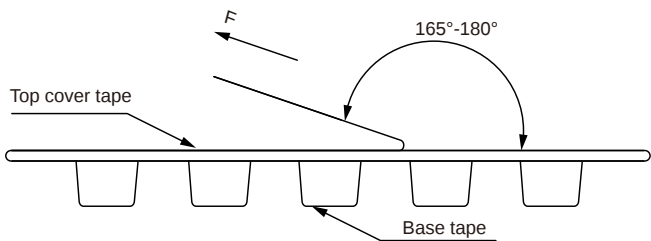
Packaging Information:

Tape Dimension :



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
LPQ?2./2@	2,03 ° ./	2,03 ° ./	/,3 ° ./	2, . ° ./	6, . ° ./	/0, . ° ./,1	/,2 ° ./	/,53 ° ./	.,1. ° ./,3

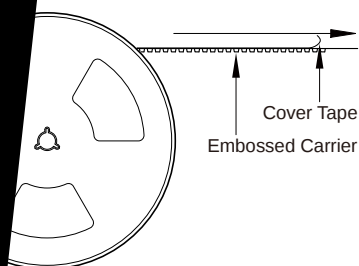
Peel force of top cover tape:



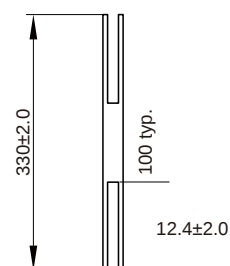
Rfc nccj dmpac md rmn amtcp r_nc qf_jj `c `crucc l .,1 rm /,/5 L



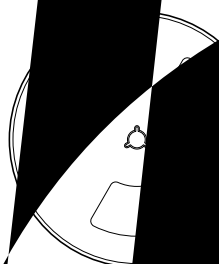
Reel Dimension: [mm]



2.2 ± 0.5



Package Quantity:



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